



2822

Atty. Dkt. No. 039153-0472 (G1177)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Besser et al.

Title: METHOD OF IMPLANTING  
COPPER BARRIER MATERIAL TO  
IMPROVE ELECTRICAL  
PERFORMANCE

Appl. No.: 09/994,397

Filing Date: 11/26/2001

Examiner: Unknown

Art Unit: 2812

S824  
11-20-02

<b>CERTIFICATE OF MAILING</b>	
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on the date below.	
<u>Sandra A. Murphy</u> (Printed Name)	
<u>Sandra A. Murphy</u> (Signature)	
November 5, 2002 (Date of Deposit)	

TRANSMITTAL OF FORMAL DRAWINGSCommissioner for Patents  
Washington, D.C. 20231

ATTENTION: DRAWING REVIEW BRANCH

Sir:

Transmitted herewith are the formal drawings (3 sheets, Figures 1-6) for the above-identified application. The Official Draftsperson is respectfully requested to approve these drawings for entry into the application.

Respectfully submitted,

Date Nov. 5, 2002By Paul S. Hunter

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